



1.35V/1.5V/1.8V 14 bit 2:1 DDR3/DDR4 Switch

Features

- → 14 bit 2:1 switch that supports DDR3 800 2133Mbps, DDR4 1600~4266 Mbps
- → VDD 1.35V/ 1.5V/ 1.8V
- → Flow through pinout option for easy layout
- → SEL and Global Enable
- → 110 μ A typ. operating current at 1.35V VDD.
- → High impedance and low Coff channel output when disabled or deselected
- \rightarrow Low R_{ON}: 8 Ω typical
- → 3dB Bandwidth: 3.3GHz
- → Low insertion loss: -0.7dB ($0 \le f \le 1$ GHz)
- → Low return loss: -23dB ($0 \le f \le 1$ GHz)
- → Low cross-talk for high speed channels: -25dB typ. (0<f<2GHz)
- → Low off-isolation: -28dB ($0 \le f \le 1$ GHz)
- → Low bit-to-bit skew 20ps Max
- → ESD: 2KV HBM
- → POD_12, SSTL_12, SSTL_135, SSTL_15 or SSTL_18 signaling
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- → Packaging (Pb-free and Green)
 - ^o 52-pin, 3.5x9mm TQFN (ZL)
 - ^a 48-pin, 4.5x4.5mm TFBGA (NC) pin compatible with CBTW28DD14

Application

- → DDR3/DDR4 Memory Bus System
- → NVDIMM Module
- → Flash Memory Array sub system
- → High Speed multiplexing

Description

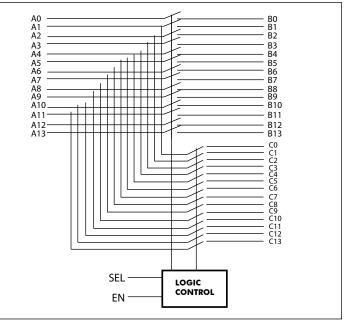
This 14-bit DDR3/DDR4 switch is designed for 1.35V/1.5V/1.8V supply voltage, POD 12, SSTL 135, SSTL 15 or SSTL 18 signaling and CMOS select input signals. It is designed for DDR3 or DDR4 memory bus with speed up to 5Gbps. It supports DDR3 800 2133Mbps and DDR4 1600~4266 Mbps.

PI2DDR3212 has a 1:2 demux or 2:1 mux topology. All 14-bit channels can be switched to one of the two ports simultaneously with the SEL input. This device also allows all ports to be disconnected.

PI2DDR3212 uses Diodes' proprietary high speed switch technology providing consistent high bandwidth across all channels, with very little insertion loss, cross-talk, and bit to bit skew.

It is available in a 52-pin TQFN 3.5x9mm package and 48-pin TFBGA 4.5x4.5mm package. The 48-pin version is pin compatible with CBTW28DD14.

Block Diagram



Notes:

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

^{1.} No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.





Pin Configuration (48-TFBGA)

Pin Configuration (52-TQFN)

		2	3	4	5	6	7	8
Α	B9	B8	B7	C7	C6	B6	B 5	B4
в	B10	C9	C8	GND	VDD	C5	C4	B3
С	B11	C10					C3	B2
D	C11	EN					SEL	C2
E	B12	C12					C1	B1
F	B13	C13					C0	B0
G	A13	A11	A9	GND	v_{DD}	A4	A2	A 0
н	A12	A10	A8	A7	A6	A5	A3	A1

in conligera			••/	
	B13 C13	B12 C12 GND		
	52	8 6 8 0 0 0		
GND EN A13 A12 A11 VDD A10 A9 A8 A7 GND A6 A5 A4 A3 VDD A2	ZS 1 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 13 14 15 17 17	Q: Q: <thq:< th=""> Q: Q: Q:<!--</th--><th>B10 C10 B9 C9 B8 C8 B7 C7 VDD B6 C6 B5</th><th></th></thq:<>	B10 C10 B9 C9 B8 C8 B7 C7 VDD B6 C6 B5	
A1 A0 SEL GND	17 18 19 20 21	30 (29 (28 (27 (В3 С3 В2	
	3 3 	36 54 □□□		
	8 8	GND BI CI		

Pin Description

Pin Name	ІО Туре	Descriptions
VDD	Power	1.35V, 1.5V or 1.8V power supply.
GND	Ground	1.35V, Ground connection
A[0:13]	I/O	14-bit wide input/output, port A
B[0:13]	I/O	14-bit wide input/output, port B
C[0:13]	I/O	14-bit wide input/output, port C
SEL	I	CMOS input for channel selection
		CMOS input
EN	Ι	When HIGH, connection is set using the SEL input signal
		When LOW, all ports are mutually isolated

Truth Table (SEL)

SEL	Function
0	Output B is selected
1	Output C is selected

Truth Table (EN)

EN	Function
1	Global Enable
0	Global Disable



Note:



PI2DDR3212

Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Supply Voltage to Ground Potential0.3V to 2.5V
All Inputs0.3V to VDD+0.3V
Ambient Operating Temperature10 to +85°C
Storage Temperature65 to +150°C
Junction Temperature
Soldering Temperature

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Recommended Operation Conditions

Parameter	Min.	Тур.	Max.	Unit
Ambient Operating Temperature	-10		+85	°C
Power Supply Voltage (measured in respect to GND)	+1.28	1.8	+2.0	V

Static Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{DD}	Supply Voltage		1.28	1.35/ 1.5/1.8	2	V
т	V. Sumply Comment	EN= HIGH; V _{DD} =1.8V		220	350	μΑ
I _{DD}	V _{DD} Supply Current	EN=LOW; V_{DD} =1.8V		0.1	10	μΑ
	V. Grander Comment	EN= HIGH; V _{DD} =1.35V		110	200	μΑ
I _{DD}	V _{DD} Supply Current	EN= LOW; V_{DD} =1.35V		0.05	2	μΑ
Control Pir	(SEL, EN)					
I _{IH}	High level digital input current	$V_{IH} = V_{DD}, V_{DD} = 2.0 V$			5	μΑ
I _{IL}	Low level digital input current	$V_{IL} = GND, V_{DD} = 2.0V$			5	μΑ
V _{IH}	High level digital input voltage		0.8 *V _{DD}			V
V _{IL}	Low level digital input voltage				0.2*V _{DD}	V
I/O Pin (A,	B ,C)					
C _{OFF}	Switch OFF capacitance	$f = 1MHz; V_{I/O} = 0V$		1.1		pF
C _{ON}	Switch ON capacitance	$f = 1MHz; V_{I/O} = 0V$		2.1		pF





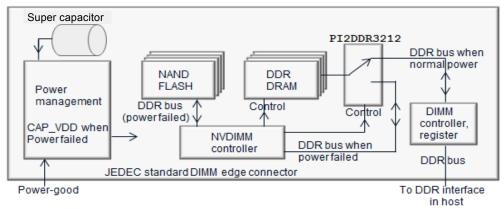
Symbol	Parameter	Test Conditions	Min.	Typ. ⁽¹⁾	Max.	Units
	Ctartan tina	Supply voltage valid or EN going		5	10	
tstartup	Startup time	HIGH to channels specified characteristics		5	10	μs
trcfg	Reconfiguration time	SEL state change to channel specified oper- ating characteristics		0.02	0.04	μο
tpd	Propagation delay	From A port to B port or C port or vice versa		60		ps
tsk	Skew time	From any output to any output		18	20	ps
VI	Input Voltage		-0.3		Vdd+0.3	V
В	Bandwidth	-3dB intercept		3.3		GHz
С	Crosstalk attenuation	Adjacent channels are on; $0 \le f \le 1$ GHz		-26		dB
т	T (° T	$0 \leq f \leq 1 GHz$		-0.7		dB
Insertion Loss		f = 2.5GHz		-2.5		dB
R _L	Input Return Loss	$0 \le f \le 1GHz$		-23		dB
OI	Off Isolation	$0 \le f \le 1 \text{ GHz}$		-28		dB

Dynamic Characteristics (over recommended operating conditions unless otherwise noted)

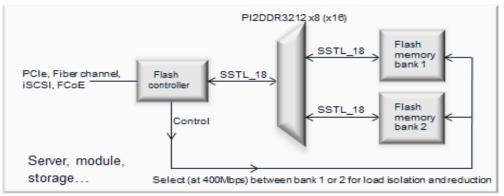




Application Diagram



NVDIMM Application using PI2DDR3212



SSD, Flash Storage Application using PI2DDR3212





Part Marking

ZL Package



YY: Year WW: Workweek 1st X: Assembly Code 2nd X: Fab Code

NC Package

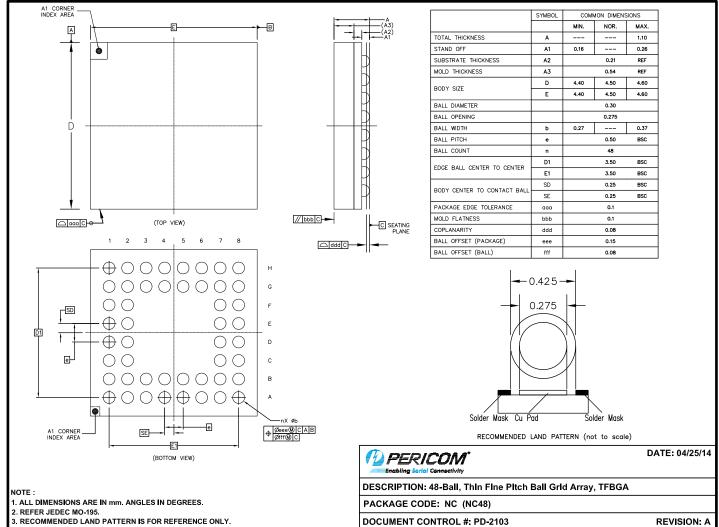


YY: Year WW: Workweek 1st X: Assembly Code 2nd X: Fab Code Bar above fab code means Cu wire





Packaging Mechanical: 48-TFBGA (NC)

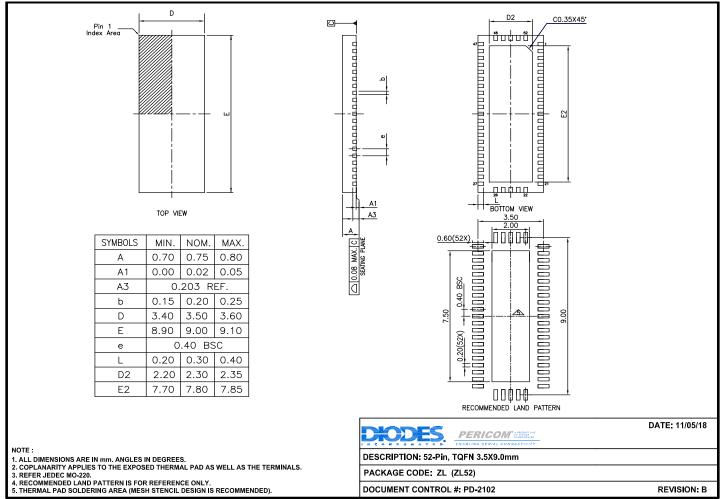


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Packaging Mechanical: 52-TQFN (ZL)



For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Packaging Code	Package Description
PI2DDR3212ZLEX	ZL	52-Pin, Thin Quad Flat No-Lead (TQFN)
PI2DDR3212NCEX	NC	48-Pin, Thin Fine Pitch Ball Grid Array (TFBGA)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. E = Pb-free and Green

5. X suffix = Tape/Reel





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